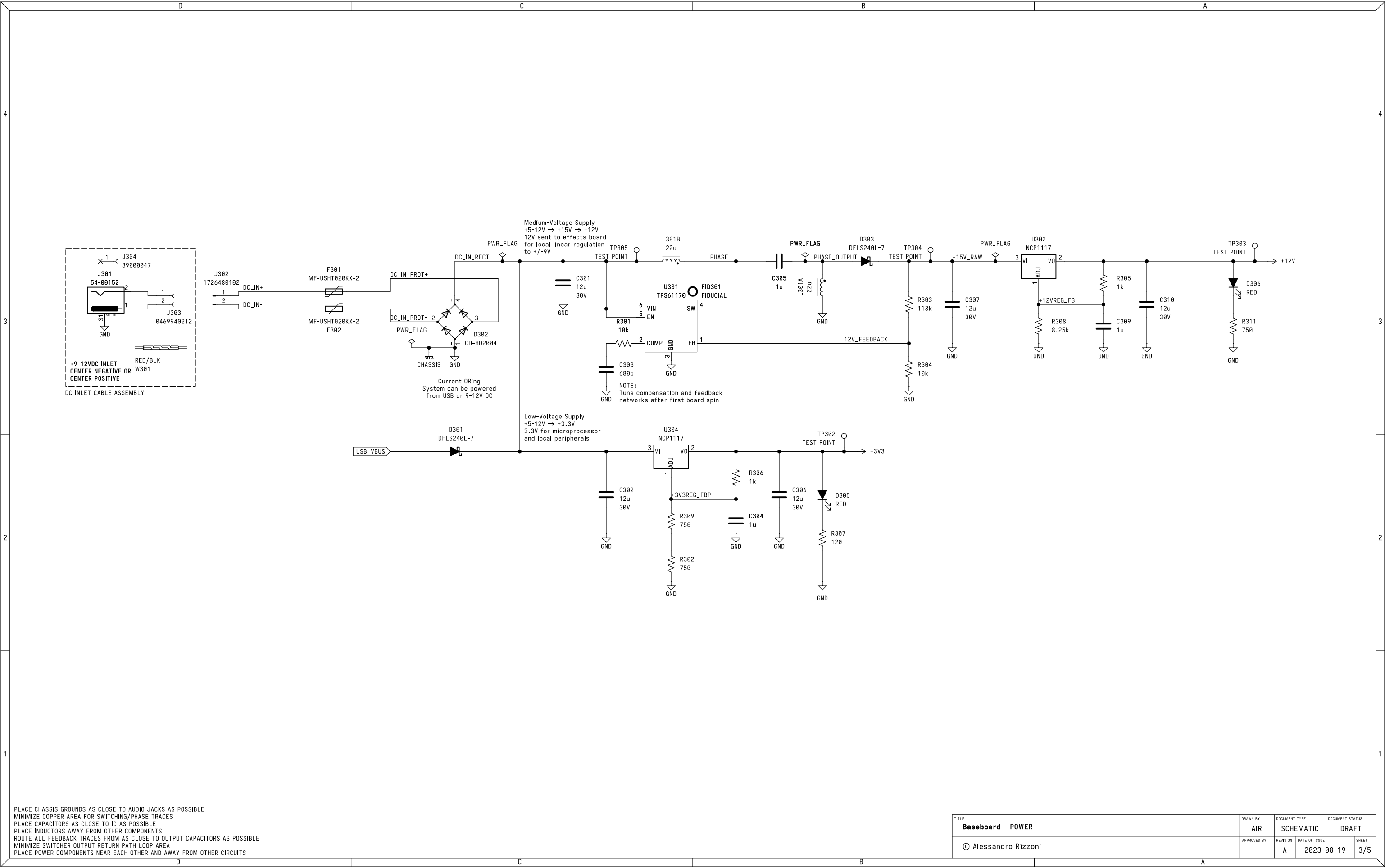
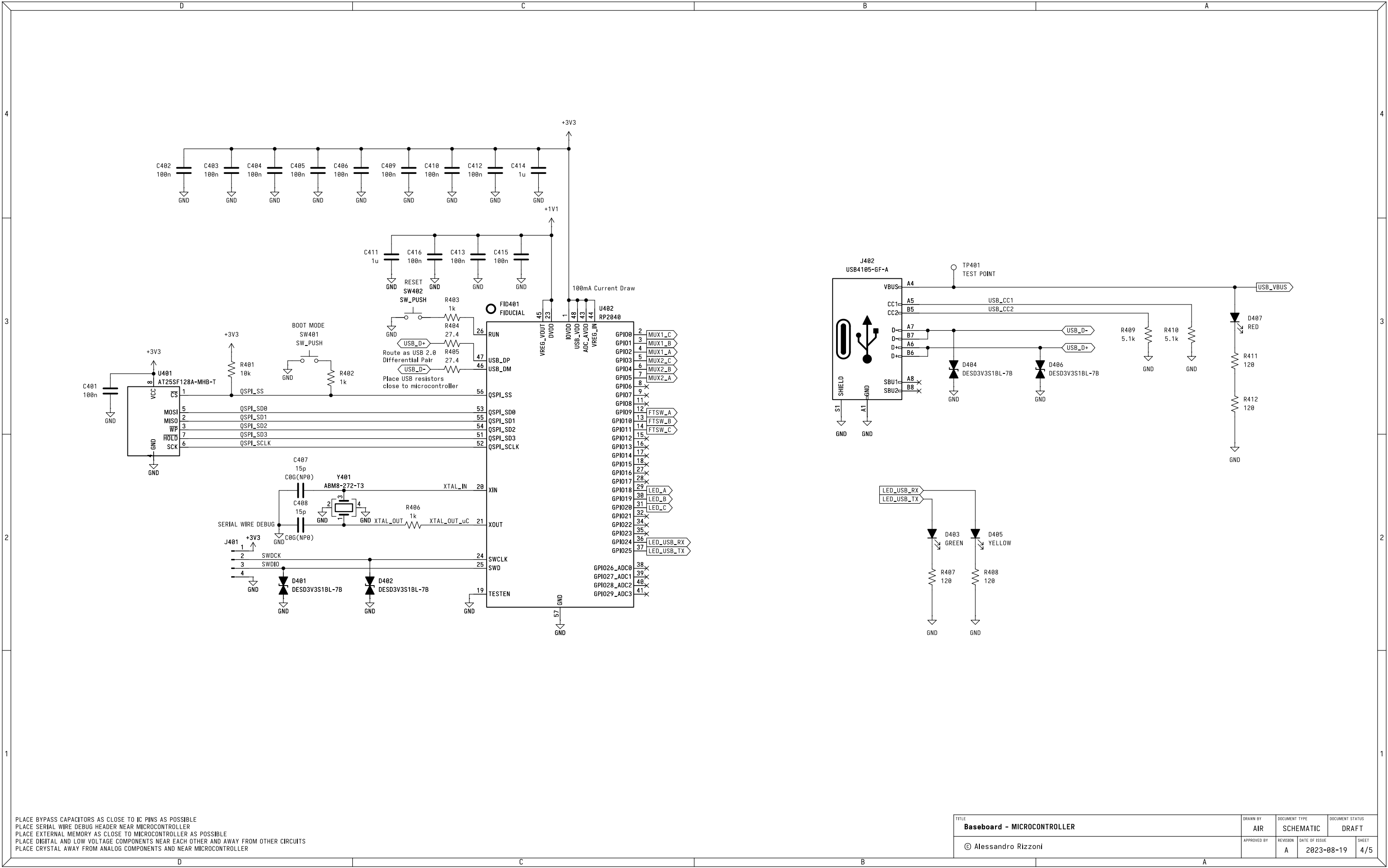


PLACE CHASSIS GROUNDS AS CLOSE TO AUDIO JACKS AS POSSIBLE
PLACE BYPASS CAPACITORS AS CLOSE TO ICs OR CONNECTORS AS POSSIBLE
PLACE CONNECTORS NEAR BOARD EDGE
PLACE AUDIO COMPONENTS NEAR EACH OTHER AND AWAY FROM OTHER CIRCUITS

TITLE Baseboard - AUDIO	DRAWN BY AIR	DOCUMENT TYPE SCHEMATIC	DOCUMENT STATUS DRAFT	
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PLACE BYPASS CAPACITORS AS CLOSE TO IC PINS AS POSSIBLE
PLACE SERIAL WIRE DEBUG HEADER NEAR MICROCONTROLLER
PLACE EXTERNAL MEMORY AS CLOSE TO MICROCONTROLLER AS POSSIBLE
PLACE DIGITAL AND LOW VOLTAGE COMPONENTS NEAR EACH OTHER AND AWAY FROM OTHER CIRCUITS
PLACE CRYSTAL AWAY FROM ANALOG COMPONENTS AND NEAR MICROCONTROLLER

TITLE Baseboard - MICROCONTROLLER	DRAWN BY AIR	DOCUMENT TYPE SCHEMATIC	DOCUMENT STATUS DRAFT
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